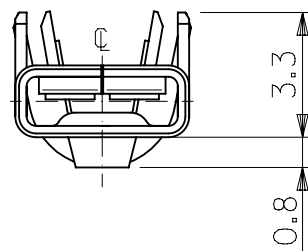


- 注)  
NOTES:
- 材質  
MATERIAL  
銅合金 (板厚: 0.3)  
COPPER ALLOY (THICKNESS: 0.3)
  - メッキ仕様  
TERMINAL PLATING  
接点部 : 金メッキ 0.25 μm MIN.  
CONTACT AREA : GOLD 0.25 MICROMETER MIN.  
圧着部 : 錫メッキ 1.0 μm MIN.  
CRIMP AREA : TIN 1.0 MICROMETER MIN.  
下地メッキ : ニッケルメッキ 2.0 μm MIN.  
UNDER PLATE : NICKEL 2.0 MICROMETER MIN.
  - 適用電線範囲 : UL 2517 , AWG #16  
APPLICABLE WIRE RANGE : UL2517 , AWG #16
  - 被覆外径 : φ2.2~φ2.7  
INSULATION EXTERNAL DIA : φ2.2~φ2.7
  - 適用ハウジングアッセンブリ : 51195 シリーズ  
APPLICABLE HOUSING ASS'Y : 51195 SERIES
  - 本製品は59319-\*\*-90の鉛フリー品である。  
THIS PRODUCT IS LEAD FREE OF 59319-\*\*\*90.



連鎖状 CHAIN	59319-0028	59319-**-28
端子形状 TERMINAL CONFIGURATION	MATERIAL No.	MODEL No.
DIMENSIONS:		SHT REV

MATERIAL 材料	—#—	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	10 UNDER 未満	±0.2	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION DIMENSION UNITS: mm SCALE: 1:1 GENERAL TOLERANCES (UNLESS SPECIFIED): 4 PLACES ±0.25 3 PLACES ±0.25 2 PLACES ±0.25 1 PLACE ±0.25 0 PLACES ±0.25 ANGULAR TOL ±0.5° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS THIRD ANGLE PROJECTION DRAWING SERIES: B-SIZE 59319 CURRENT REV DESC: OBSOLETE PART NUMBER EC NO: 638770 DRWN: VLOKESHA 2020/03/12 CHK'D: GGA 2020/07/21 APPR: GGA 2020/07/21 INITIAL REVISION: DRWN: Y.WADA 2004/03/29 APPR: M.SASAO 2004/03/29	<b>molex</b> POWER REC CRIMP TERM -LEAD FREE- PRODUCT CUSTOMER DRAWING DOCUMENT NUMBER: SD-59319-002 DOC TYPE: PSD DOC PART: 001 REVISION: A MATERIAL NUMBER: SEE CHART CUSTOMER: GENERAL MARKET SHEET NUMBER: 1 OF 1
FINISH 仕上げ	—#—	10 OVER 30 UNDER 以上 未満	±0.25			
WIRE RANGE 適用電線範囲	—#—	30 OVER 以上	±0.3			
INS. RANGE 被覆外径	—#—	ANGLE 角度	±3°			